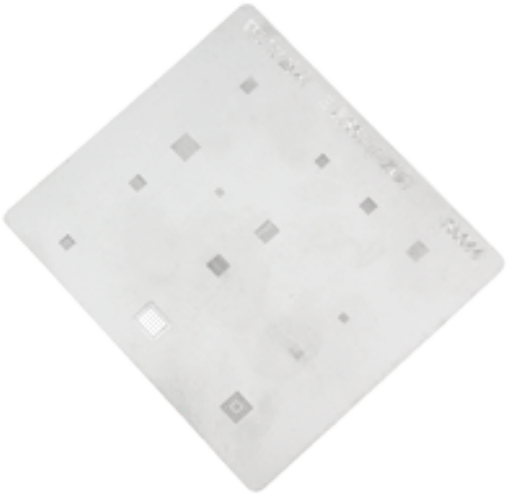
MULTI-COM.PL



BGA stencil for Samsung S6 Edge (SM-G925F)

Product ID: 21747

Price: **6.20 EUR**

Product weight: **0.02 kg**

Description:

BGA stencil for Samsung S6 Edge (SM-G925F) plaiting kit it's a BGA stencil matrix needed when you have to exchange BGA parts of your phone and wan't to apply BGA balls into IC.

Contact details:
Telefon: +48 17 227 00 25
Infolinia:0 801 671 717
E-mail: biuro@multi-com.pl
Skype: Multi-COM

Adsress:
Multi-COM Sp. z o.o.
ul. Stanisława Krzaklewskiego 31b
36-100 Kolbuszowa
POLSKA

Go to the product

Datasheet valid 2018-02-24 06:12:02